



Messe München

Connecting Global Competence

Plan of the trade fair grounds



The West Entrance will be open for productronica 2019 and SEMICON Europa 2019. The East Entrance will be used for productronica 2019 and the parallel event InPrint 2019.
 Last update: 09/2018

- A1** **SMT cluster**
 Test and measurement, quality assurance
 ■ productronica Forum
- A2** **SMT cluster**
 Test and measurement, quality assurance
 Component mount technology
 Production logistics and material-flow technology
- A3** **SMT cluster**
 Component mount technology
- A4** **SMT cluster**
 Soldering and joining technology for PCBs
 Product finishing
- A5** **Cables, Coils & Hybrids cluster**
 Technologies for cables processing and connectors
 Coilware production
 Hybrid components manufacturing
- A6** **InPrint 2019**
 November 12–14, 2019

ICM B1/B2 **SEMICON Europa 2019**
 November 12–15, 2019



- B2** **Future Markets cluster**
 IT to Production, Industry 4.0
 Technologies for batteries and electrical energy storage
 Organic and printed electronics
 3D printing, additive manufacturing
 ■ Innovation Forum
- B2** **Semiconductors cluster**
 Semiconductor manufacturing
 Display manufacturing, LEDs and discrete devices
 Photovoltaics manufacturing
 Micro-/nano-production
 Cleanroom technology
 Materials processing
- B3** **PCB & EMS cluster**
 PCB and other circuit carrier manufacturing
 Electronic manufacturing services (EMS)
 ■ PCB & EMS Speakers Corner



co-located event



productronica 2019

World's Leading Trade Fair for Electronics
 Development and Production
 November 12–15, 2019, Messe München
productronica.com